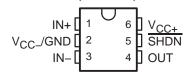
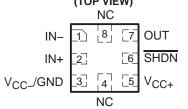
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- 1.8-V, 2.7-V, and 5-V Specifications
- Rail-to-Rail Output Swing
 - 600- Ω Load . . . 80 mV From Rail
 - 2-k Ω Load . . . 30 mV From Rail
- V_{ICR} . . . 200 mV Beyond Rails
- Gain Bandwidth . . . 1.4 MHz
- Supply Current . . . 100 μA/Amplifier
- Max V_{IO} . . . 4 mV
- Turn-On Time From Shutdown . . . 8.4 μs
- Space-Saving Packages
 - LMV981: SOT-23-6, SC-70, and QFN
 - LMV982: MSOP and VSSOP
- Applications
 - Industrial (Utility/Energy Metering)
 - Automotive
 - Communications (Optical Telecom, Data/Voice Cable Modems)
 - Consumer Electronics (PDAs, PCs, CDR/W, Portable Audio)
 - Supply-Current Monitoring
 - Battery Monitoring

LMV981 . . . DBV (SOT23-6) OR DCK (SC-70) PACKAGE (TOP VIEW)

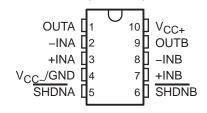


LMV981 . . . RUG (QFN) PACKAGE (TOP VIEW)



NC - No internal connection

LMV982 . . . DGS (VSSOP/MSOP) PACKAGE (TOP VIEW)



description/ordering information

The LMV981 and LMV982 devices are low-voltage, low-power operational amplifiers that are well suited for today's low-voltage and/or portable applications. Specified for operation of 1.8 V to 5 V, they can be used in portable applications that are powered from a single-cell Li-ion or two-cell batteries. They have rail-to-rail input and output capability for maximum signal swings in low-voltage applications. The LMV98x input common-mode voltage extends 200 mV beyond the rails for increased flexibility. The output can swing rail-to-rail unloaded and typically can reach 80 mV from the rails, while driving a $600-\Omega$ load (at 1.8-V operation).

ORDERING INFORMATION†

TA		PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING§	
		QFN (RUG)	Reel of 3000	LMV981IRUGR	R7	
	Single	007.00 (DD) ()	Reel of 3000	LMV981IDBVR	RBA_	
		SOT-23 (DBV)	Reel of 250	LMV981IDBVT	PREVIEW	
-40°C to 125°C		SC-70 (DCK)	Reel of 3000	LMV981IDCKR	R7_	
			Reel of 250	LMV981IDCKT	PREVIEW	
	Dual	MCODA/CCOD (DCC)	Reel of 2500	LMV982IDGSR	505	
	Dual	MSOP/VSSOP (DGS)	Reel of 250	LMV982IDGST	RCB	

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

[§] DBV/DCK: The actual top-side marking has one additional character that designates the wafer fab/assembly site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡] Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

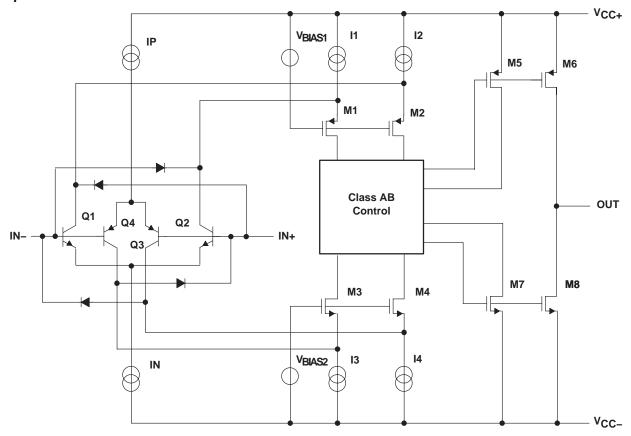
description/ordering information (continued)

The LMV981 and LMV982 devices offer shutdown capability for additional power savings. Pulling the SHDN pin low puts the amplifiers in shutdown, where only 0.156 μ A typically is consumed from a 1.8-V supply. In normal operation with the same 1.8-V supply, the devices typically consume a quiescent current of 103 μ A per channel, and yet they are able to achieve excellent electrical specifications, such as 101-dB open-loop DC gain and 1.4-MHz-gain bandwidth. Furthermore, the amplifiers offer good output drive characteristics, with the ability to drive a 600- Ω load and 1000-pF capacitance, with minimal ringing.

The LMV981 and LMV982 devices are offered in the latest packaging technology to meet the most demanding space-constraint applications. The LMV981 is offered in standard SOT-23 and SC-70 packages. The LMV982 is available in the 10-pin MSOP package.

The LMV98x devices are characterized for operation from –40°C to 125°C, making them universally suited for commercial, industrial, and automotive applications.

simplified schematic





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absolute maximum ratings over free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC+} – V _{CC-} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	Supply voltage
Input voltage range, V _I (either input)	V_{CC-} – 0.2 V to V_{CC+} + 0.2 V
Duration of output short circuit (one amplifier) to V _{CC} ± (see Note	es 3 and 4)Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5): DBV package	ckage 165°C/W
DCK pa	ckage 259°C/W
DGS pa	ckage 165°C/W
RUG pa	ckage 253°C/W
Operating virtual junction temperature, T _J	•
Storage temperature range, T _{stq}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. Applies to both single-supply and split-supply operation. Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum-allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.
 - 4. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
Vcc	Supply voltage (V _{CC+} – V _{CC} –)	1.8	5	V
TA	Operating free-air temperature	-40	125	°C

ESD protection

TEST CONDITIONS	TYP	UNIT
Human-Body Model	2000	V
Machine Model	200	V



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electrical characteristics at T_A = 25°C, V_{CC+} = 1.8 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted)

	PARAMETER		TEST CONDITIONS		TA	MIN	TYP	MAX	UNIT		
					25°C		1	4			
.,			LMV981 (sing	ıle)	Full range			6	.,		
V_{IO}	Input offset voltage	9	LAA) (000 (-l1)		25°C		1	5.5	mV		
			LMV982 (dual)		Full range			7.5			
$\alpha_{V_{\text{IO}}}$	Average temperate coefficient of input voltage				25°C		5.5		μV/°C		
			VIC = VCC+	- 0.8 V	25°C		15	35			
l _{IB}	Input bias current				25°C			65	nA		
					Full range			75			
I have to all a support				25°C		13	25	~ ^			
ΙO	Input offset current				Full range			40	nA		
				25°C		103	185				
					Full range			205			
Icc	Supply current (per channel			LMV981	25°C		0.156	1	μΑ		
icc	Зарріу сапені (ре	i Chamilei)	In shutdown	LIVIV 90 1	Full range			2	μΑ		
		III SIIddowii	LM982	25°C		0.178	3.5				
				LIVISOZ	Full range			5			
			$0 \le V_{IC} \le 0.6$		25°C	60	78				
			1.4 V ≤ V _{IC} ≤ 1.8 V		-40°C to 85°C	55					
CMRR	Common-mode re ratio	jection	$0.2 \text{ V} \le \text{V}_{\text{IC}} \le 0.6 \text{ V},$ $1.4 \text{ V} \le \text{V}_{\text{IC}} \le 1.6 \text{ V}$		-40°C to 125°C	55			dB		
			$-0.2 \text{ V} \le \text{V}_{\text{IC}} \le 0 \text{ V},$ 1.8 V \le \text{V}_{\text{IC}} \le 2 \text{V}		25°C	50	72				
	Supply-voltage rej	ection	1.8 V ≤ V _{CC+}	. ≤5 V,	25°C	75	100		-ID		
ksvr	ratio		V _{IC} = 0.5 V		Full range	70			dB		
					25°C	V _{CC} 0.2	-0.2 to 2.1	V _{CC+} + 0.2			
^V ICR	Common-mode in range	out voltage	CMRR ≥ 50 d	В	-40°C to 85°C	V _{CC} -		V _{CC+}	V		
					-40°C to 125°C	V _{CC} _+0.2		V _{CC+} -0.2			
			$R_L = 600 \Omega \text{ to}$ $V_O = 0.2 \text{ V to}$		25°C	77	101				
		1.843/004	V _{IC} = 0.5 V	,	Full range	73					
		LMV981	$R_L = 2 k\Omega$ to $V_O = 0.2 V$ to	0.9 V,	25°C	80	105				
Ay	voltage gain		V _{IC} = 0.5 V		Full range	75			dB		
· •v			$R_L = 600 \Omega \text{ to}$ $V_O = 0.2 \text{ V to}$		25°C	75	90		uъ		
		LMV982	V _O = 0.2 V to 1.6 V, V _{IC} = 0.5 V		Full range	72					
			$\begin{array}{c} \text{RL} = 2 \text{ k}\Omega \text{ to } 0.9 \text{ V}, \\ \text{VO} = 0.2 \text{ V to } 1.6 \text{ V}, \\ \text{VIC} = 0.5 \text{ V} \end{array}$		25°C	78	100				
					Full range	75					



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electrical characteristics at T_A = 25°C, V_{CC+} = 1.8 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

	PARAMETER	TEST CONDITION	NS	TA	MIN	TYP	MAX	UNIT
				25°C	1.65	1.72		
		$R_L = 600 \Omega \text{ to } 0.9 \text{ V},$	High level	Full range	1.63			
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.077	0.105	
\/ -	Output suits s		Low level	Full range			0.12	V
VO	Output swing		High level	25°C	1.75	1.77		V
		$R_L = 2 k\Omega$ to 0.9 V,		Full range	1.74			
		$V_{ID} = \pm 100 \text{ mV}$		25°C		0.024	0.035	
			Low level	Full range			0.04	
		V _O = 0 V,	= 0 V,		4	8		
١.	Output	V _{ID} = 100 mV	Sourcing	Full range	3.3			^
los	short-circuit current	V _O = 1.8 V,	Cialia a	25°C	7	9		mA
		$V_{ID} = -100 \text{ mV}$	Sinking	Full range	5			
T _{on}	Turn-on time from shutdown			25°C		19		μs
VSHDN	Turn-on voltage to enable part			25°C		1.0		V
Cribit	Turn-off voltage	1			0.55			
GBW	Gain bandwidth product			25°C		1.4		MHz
SR	Slew rate	See Note 6		25°C		0.35		V/μS
Φ_{m}	Phase margin			25°C		67		deg
	Gain margin			25°C		7		dB
Vn	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V	25°C		60		nV/√ Hz	
In	Equivalent input noise current	f = 1 kHz	25°C		0.06		pA/√ Hz	
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600$ $V_{ID} = 1 V_{PP}$	25°C		0.023		%	
	Amp-to-amp isolation	See Note 7		25°C		123		dB

NOTES: 6. Number specified is the slower of the positive and negative slew rates.

7. Input referred, $V_{CC+} = 5 \text{ V}$ and $R_L = 100 \text{ k}\Omega$ connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_{O} = 3 \text{ V}_{PP}$.



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electrical characteristics at T_A = 25°C, V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted)

	PARAMETER		TEST CON	IDITIONS	T _A	MIN	TYP	MAX	UNIT	
					25°C		1	4		
.,			LMV981 (sing	gle)	Full range			6	.,	
V _{IO}	Input offset voltag	je	LMV982 (dual)		25°C		1	5.5	mV	
					Full range			7.5		
$\alpha_{V_{IO}}$	Average tempera coefficient of inpuvoltage				25°C		5.5		μV/°C	
			VIC = VCC+	– 0.8 V	25°C		15	35		
I _{IB}	Input bias current				25°C			65	nA	
				Full range			75			
land Madagan					25°C		8	25	_	
IIO	Input offset curre	Input offset current			Full range			40	nA	
					25°C		105	190		
					Full range			210		
	0					25°C		0.61	1	
ICC	Supply current (p	er channel)	In shutdown	LMV981	Full range			2	μΑ	
					25°C		0.101	3.5		
				LM982	Full range			5		
			$0 \le V_{ C} \le 1.5 \text{ V},$ $2.3 \text{ V} \le V_{ C} \le 2.7 \text{ V}$		25°C	60	81			
					-40°C to 85°C	55				
CMRR	Common-mode r ratio	ejection	$0.2 \le V_{ C} \le 1.5 \text{ V},$ $2.3 \text{ V} \le V_{ C} \le 2.5 \text{ V}$		-40°C to 125°C	55			dB	
			-0.2 V ≤ V _{IC} ≤ 0 V, 2.7 V ≤ V _{IC} ≤ 2.9 V		25°C	50	74			
	Supply-voltage re	jection	1.8 V ≤ V _{CC} -	+ ≤ 5 V,	25°C	75	100			
ksvr	ratio	•	V _{IC} = 0.5 V	•	Full range	70			dB	
					25°C	V _{CC} 0.2	-0.2 to 3.0	V _{CC+} + 0.2		
VICR	Common-mode in range	nput voltage	CMRR ≥ 50 c	dΒ	-40°C to 85°C	V _{CC} -		V _{CC+}	V	
	range				-40°C to 125°C	V _{CC} _+0.2		V _{CC+} -0.2		
			R _L = 600 Ω t	to 1.35 V,	25°C	87	104			
			$V_0 = 0.2 \text{ V to}$		Full range	86				
	A _V Large-signal voltage gain	LMV981	$R_L = 2 k\Omega$ to	1.35 V,	25°C	92	110			
۸			$V_0 = 0.2 \text{ V to}$		Full range	91			dB	
AV			R _L = 600 Ω to	o 1.35 V,	25°C	78	90			
		L NAV (000		$V_O = 0.2 \text{ V to } 2.5 \text{ V}$		75				
		LMV982	$R_L = 2 \text{ k}\Omega \text{ to } 1.35 \text{ V},$ VO = 0.2 V to 2.5 V		25°C	81	100		1	
					Full range	78				

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characteristics at T_A = 25°C, V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

	PARAMETER	TEST CONDITIO	NS	TA	MIN	TYP	MAX	UNIT
				25°C	2.55	2.62		
		$R_L = 600 \Omega \text{ to } 1.35 \text{ V},$	High level	Full range	2.53			
		$V_{ID} = \pm 100 \text{ mV}$	Laurianal	25°C		0.083	0.11	
\ \/ -	Output puis a		Low level	Full range			0.13	V
Vo	Output swing		High level	25°C	2.65	2.675		V
		$R_L = 2 k\Omega$ to 1.35 V,		Full range	2.64			
		$V_{ID} = \pm 100 \text{ mV}$		25°C		0.025	0.04	
			Low level	Full range			0.045	
		V _O = 0 V,	0	25°C	20	30		
١.	Output short-circuit	V _{ID} = 100 mV	Sourcing	Full range	15			^
los	current	V _O = 2.7 V,	Cimbin m	25°C	18	25		mA
		$V_{ID} = -100 \text{ mV}$	Sinking	Full range	12			
T _{on}	Turn-on time from shutdown			25°C		12.5		μs
VSHDN	Turn-on voltage to enable part			25°C		1.9		V
	Turn-off voltage	1			0.8			
GBW	Gain bandwidth product			25°C		1.4		MHz
SR	Slew rate	See Note 6		25°C		0.4		V/μS
Φ_{m}	Phase margin			25°C		70		deg
	Gain margin			25°C		7.5		dB
Vn	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V		25°C		57		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C		0.082		pA/√ Hz	
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600$ $V_{ID} = 1 \text{ VPP}$	25°C		0.022	_	%	
	Amp-to-amp isolation	See Note 7		25°C		123		dB

NOTES: 6. Number specified is the slower of the positive and negative slew rates.



^{7.} Input referred, $V_{CC+} = 5 \text{ V}$ and $R_L = 100 \text{ k}\Omega$ connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_{O} = 3 \text{ V}_{PP}$.

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electrical characteristics at T_A = 25°C, V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	TA	MIN	TYP	MAX	UNIT	
					25°C		1	4		
l			LMV981 (sing	gle)	Full range			6		
V _{IO}	Input offset volta	age			25°C		1	5.5	mV	
			LMV982 (dua	LMV982 (dual)				7.5		
$\alpha_{V_{IO}}$	Average temper coefficient of inp voltage				25°C		5.5		μV/°C	
	I _{IB} Input bias current		VIC = VCC+	– 0.8 V	25°C		15	35		
I _{IB}					25°C			65	nA	
					Full range			75		
	I _{IO} Input offset current				25°C		9	25		
IIO					Full range			40	nA	
				25°C		116	210			
					Full range			230		
					25°C		0.201	1		
ICC	Supply current (per channel)	In shutdown	LMV981	Full range			2	μΑ	
					25°C		0.302	3.5		
				LM982	Full range			5		
			0 ≤ V _{IC} ≤ 3.8	V,	25°C	60	86			
			$4.6 \text{ V} \leq \text{V}_{1\text{C}} \leq 5 \text{ V}$		-40°C to 85°C	55				
CMRR	Common-mode ratio	rejection	$0.3 \le V_{ C} \le 3.8 \text{ V},$ $4.6 \text{ V} \le V_{ C} \le 4.7 \text{ V}$		-40°C to 125°C	55			dB	
			-0.2 V ≤ V _{IC} ≤ 0 V, 5 V ≤ V _{IC} ≤ 5.2 V		25°C	50	78			
	Supply-voltage	ejection	1.8 V ≤ V _{CC} -	₊ ≤ 5 V,	25°C	75	100		15	
k _{SVR}	ratio	•	V _{IC} = 0.5 V	•	Full range	70			dB	
					25°C	V _{CC} 0.2	-0.2 to 5.3	V _{CC+} + 0.2		
VICR	Common-mode range	input voltage	CMRR ≥ 50 c	dΒ	-40°C to 85°C	V _{CC} -		V _{CC} +	V	
	range				-40°C to 125°C	V _{CC} _+0.3		V _{CC+} -0.3		
			R _L = 600 Ω 1	to 2.5 V,	25°C	88	102			
			$V_{O} = 0.2 \text{ V to}$		Full range	87				
	A _V Large-signal voltage gain	LMV981	$R_L = 2 k\Omega$ to	2.5 V,	25°C	94	113			
Δ			$V_0 = 0.2 \text{ V to}$		Full range	93			40	
AV		ge gain R	R _L = 600 Ω to	o 2.5 V,	25°C	81	90		dB	
			$V_O = 0.2 \text{ V to } 4.8 \text{ V}$		Full range	78				
			$R_L = 2 \text{ k}\Omega \text{ to } 2.5 \text{ V},$ $V_O = 0.2 \text{ V to } 4.8 \text{ V}$		25°C	85	100		1	
					Full range	82				



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electrical characteristics at T_A= 25°C, V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

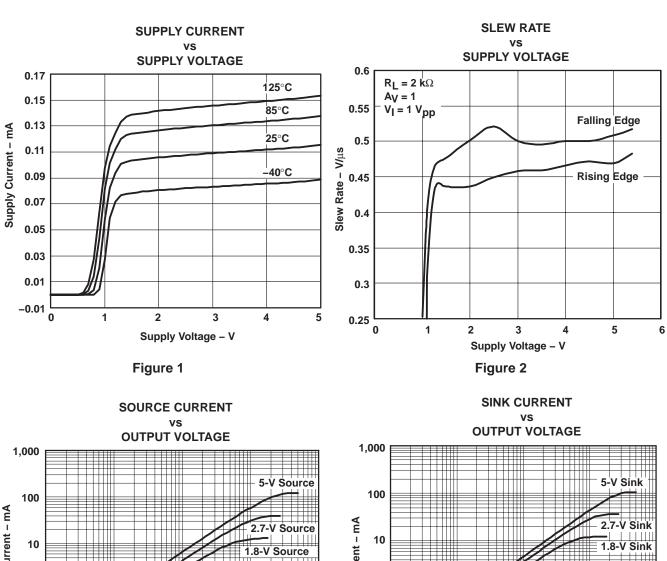
PARAMETER		TEST CONDITION	TEST CONDITIONS			TYP	MAX	UNIT
				25°C	4.855	4.89		
		$R_L = 600 \Omega \text{ to } 2.5 \text{ V},$	High level	Full range	4.835			
		$V_{ID} = \pm 100 \text{ mV}$	Laurianal	25°C		0.12	0.16	1
\	Output swing		Low level	Full range			0.18	V
VO			High lovel	25°C	4.945	4.967		V
		$R_L = 2 k\Omega$ to 2.5 V,	High level	Full range	4.935			
		$V_{ID} = \pm 100 \text{ mV}$	1 11	25°C		0.037	0.065	
			Low level	Full range			0.075	
		LMV981:	Carrelian	25°C	80	100		
	Output short-circuit	$V_{O} = 0 \text{ V}, V_{ID} = 100 \text{ mV}$	Sourcing	Full range	68			A
los	current	\/- E\/\/- 400 m\/	Cintring	25°C	58	65		mA
		$V_O = 5 \text{ V}, V_{ID} = -100 \text{ mV}$	Sinking	Full range	45			
T _{on}	Turn-on time from shutdown			25°C		8.4		μS
VSHDN	Turn-on voltage to enable part			25°C		4.2		V
0	Turn-off voltage	1			0.8			
GBW	Gain bandwidth product			25°C		1.5		MHz
SR	Slew rate	See Note 6		25°C		0.42		V/μS
Φ_{m}	Phase margin			25°C		71		deg
	Gain margin			25°C		8		dB
Vn	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 1 V		25°C		50		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C		0.07		pA/√ Hz	
THD	Total harmonic distortion	f = 1 kHz, A _V = 1, R _L = 600 V _{ID} = 1 V _{PP}	Ω,	25°C		0.022		%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

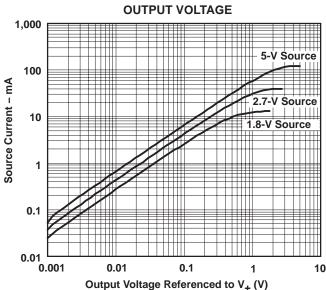
NOTES: 6. Number specified is the slower of the positive and negative slew rates.

7. Input referred, $V_{CC+} = 5 \text{ V}$ and $R_L = 100 \text{ k}\Omega$ connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_{O} = 3 \text{ V}_{PP}$.

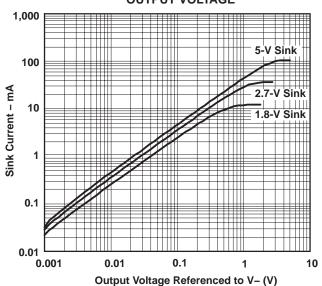


TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$

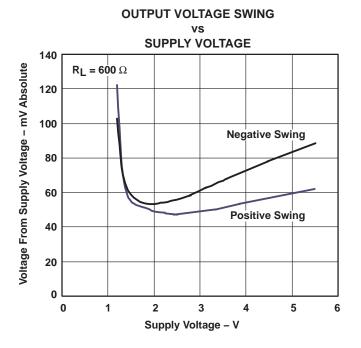






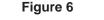


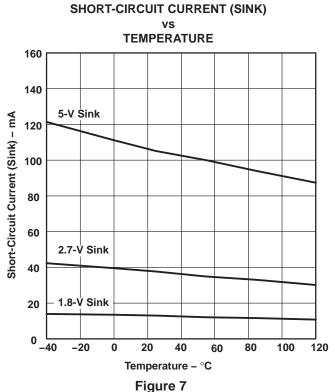
TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25 ^{\circ}\text{C}$

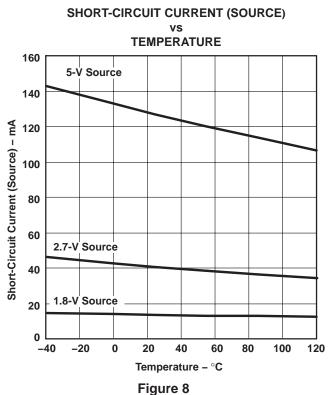


OUTPUT VOLTAGE SWING SUPPLY VOLTAGE 45 $R_L = 2^{\prime} k\Omega$ Voltage From Supply Voltage - mV Absolute 40 35 **Negative Swing** 30 25 20 15 **Positive Swing** 10 5 0 0 1 2 3 4 5 6 Supply Voltage - V

Figure 5







TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$

1.8-V FREQUENCY RESPONSE

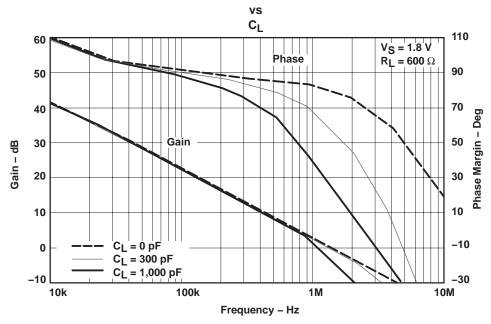


Figure 9

5-V FREQUENCY RESPONSE

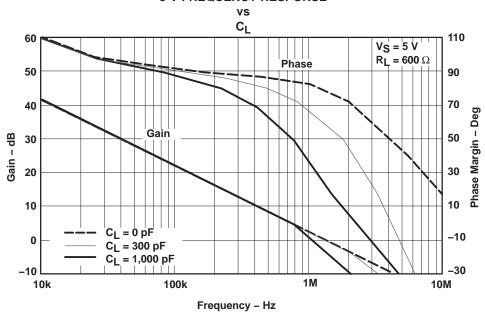


Figure 10



TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25 ^{\circ}\text{C}$

1.8-V FREQUENCY RESPONSE

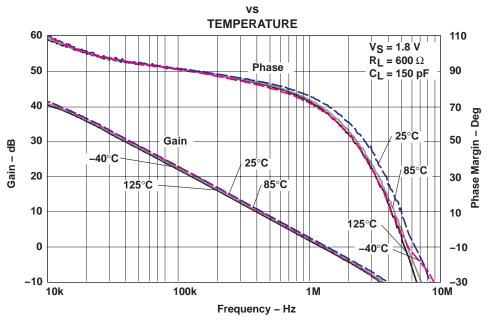


Figure 11

5-V FREQUENCY RESPONSE

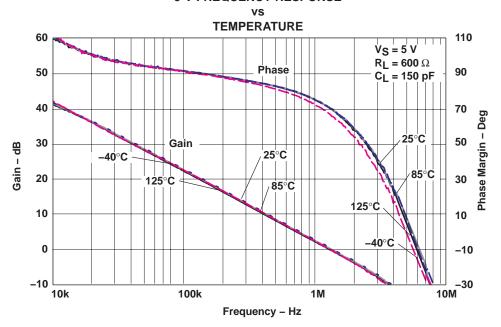
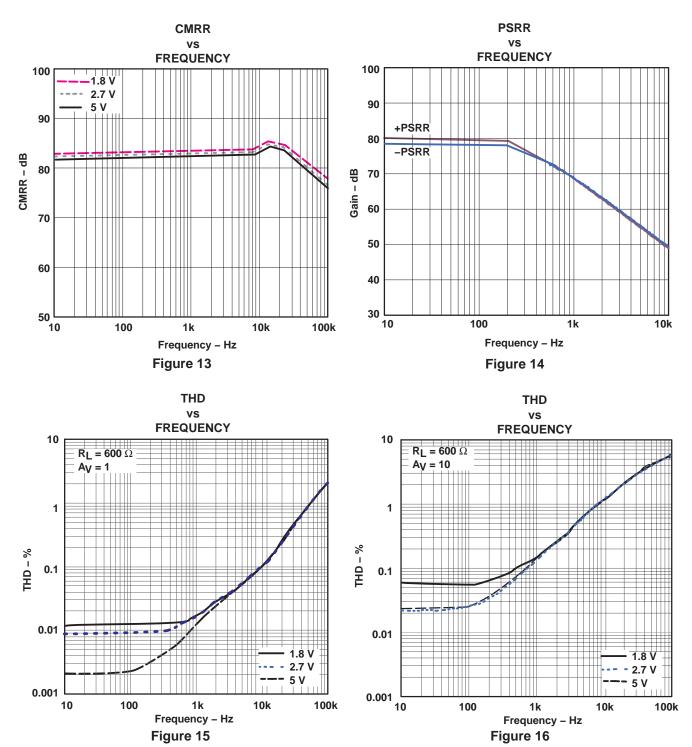


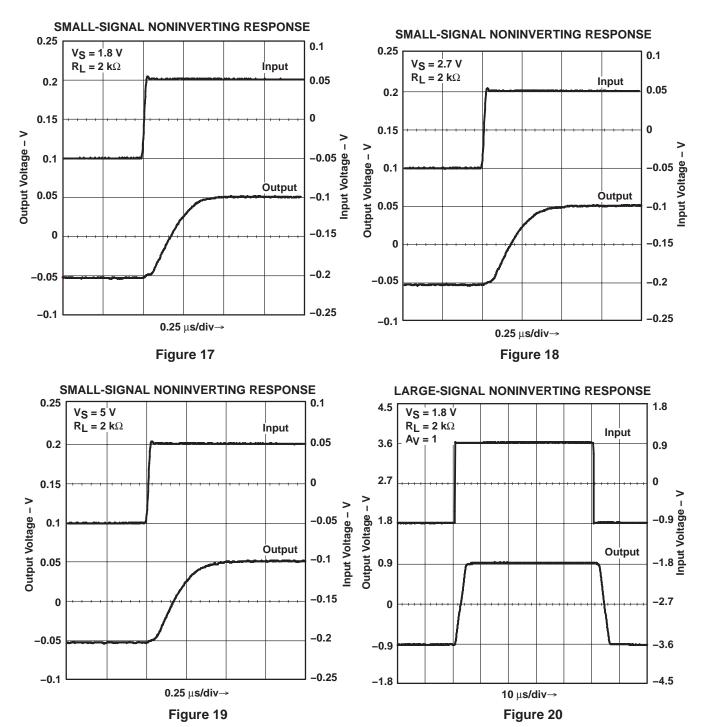
Figure 12

TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+}=5$ V, Single Supply, $T_A=25^{\circ}C$

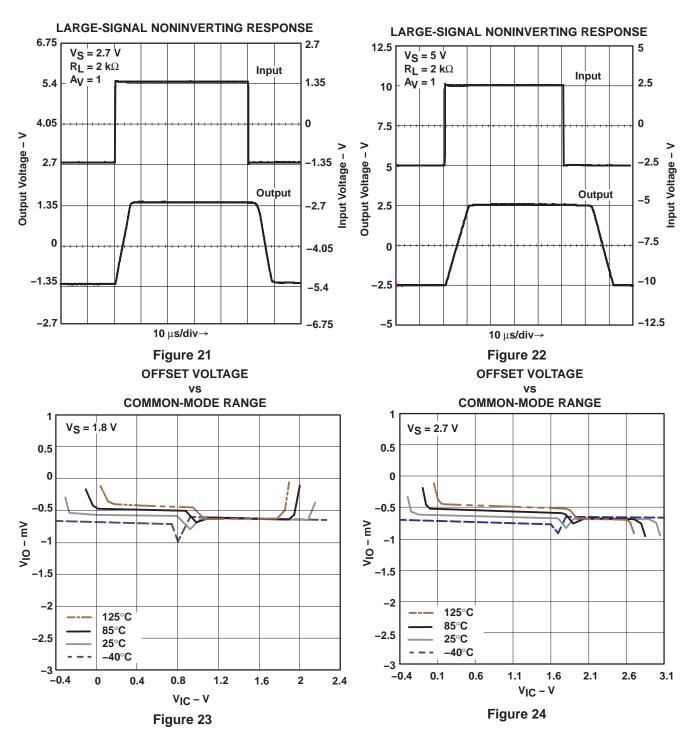




TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5$ V, Single Supply, $T_A = 25$ °C



TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25^{\circ}\text{C}$





TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+}=5$ V, Single Supply, $T_A=25^{\circ}C$

OFFSET VOLTAGE vs **COMMON-MODE RANGE** V_S = 5 V 0.5 0 -0.5 VIO - mV -1.5 -2 125°C 85°C -2.5 25°C -40°C -3 -0.4 0.6 1.6 2.6 3.6 4.6 5.6 VIC - V

Figure 25

PACKAGE OPTION ADDENDUM

www.ti.com 22-Apr-2009

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LMV981IDBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IDBVRE4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IDBVRG4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IDCKR	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IDCKRE4	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IDCKRG4	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IRUGR	ACTIVE	QFN	RUG	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV981IRUGRG4	ACTIVE	QFN	RUG	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV982IDGSR	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV982IDGSRE4	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV982IDGSRG4	ACTIVE	MSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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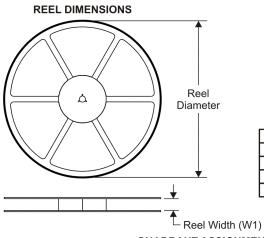
PACKAGE OPTION ADDENDUM

22-Apr-2009 www.ti.com to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 1-May-2009

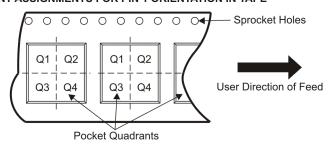
TAPE AND REEL INFORMATION





_		
		Dimension designed to accommodate the component width
Γ	B0	Dimension designed to accommodate the component length
	K0	Dimension designed to accommodate the component thickness
Γ	W	Overall width of the carrier tape
Γ	P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV981IDBVR	SOT-23	DBV	6	3000	180.0	9.2	3.23	3.17	1.37	4.0	8.0	Q3
LMV981IDCKR	SC70	DCK	6	3000	180.0	8.4	2.24	2.34	1.22	4.0	8.0	Q3
LMV981IRUGR	QFN	RUG	8	3000	180.0	9.2	1.6	1.6	0.66	4.0	8.0	Q2
LMV981IRUGR	QFN	RUG	8	3000	179.0	8.4	1.7	1.7	0.6	4.0	8.0	Q2
LMV982IDGSR	MSOP	DGS	10	2500	330.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 1-May-2009

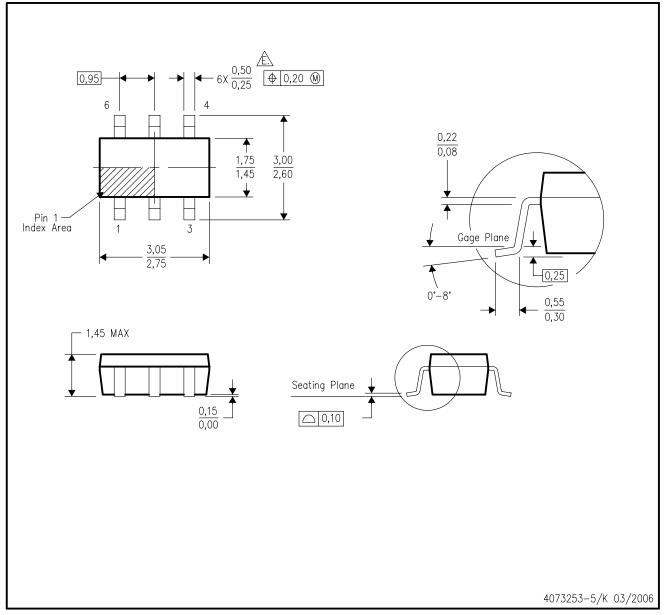


*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV981IDBVR	SOT-23	DBV	6	3000	202.0	201.0	28.0
LMV981IDCKR	SC70	DCK	6	3000	202.0	201.0	28.0
LMV981IRUGR	QFN	RUG	8	3000	202.0	201.0	28.0
LMV981IRUGR	QFN	RUG	8	3000	220.0	205.0	50.0
LMV982IDGSR	MSOP	DGS	10	2500	370.0	355.0	55.0

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



DGS (S-PDSO-G10)

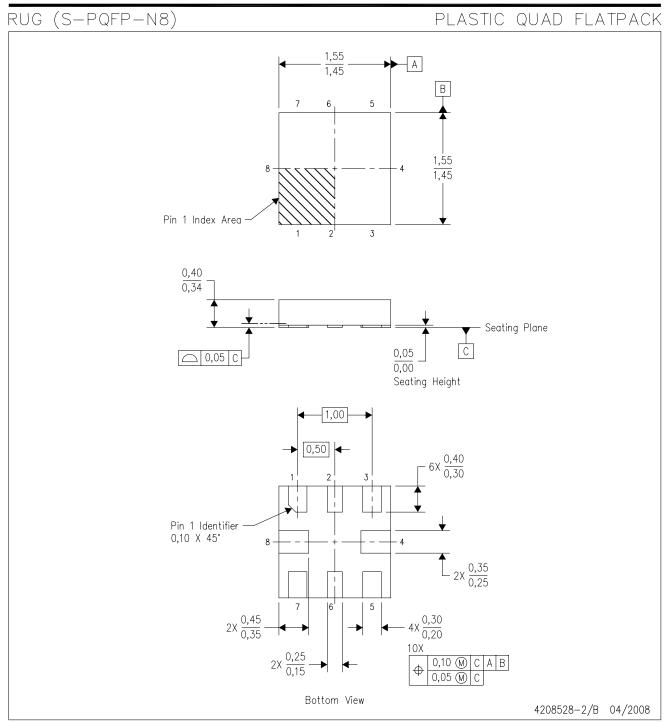
PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187 variation BA.





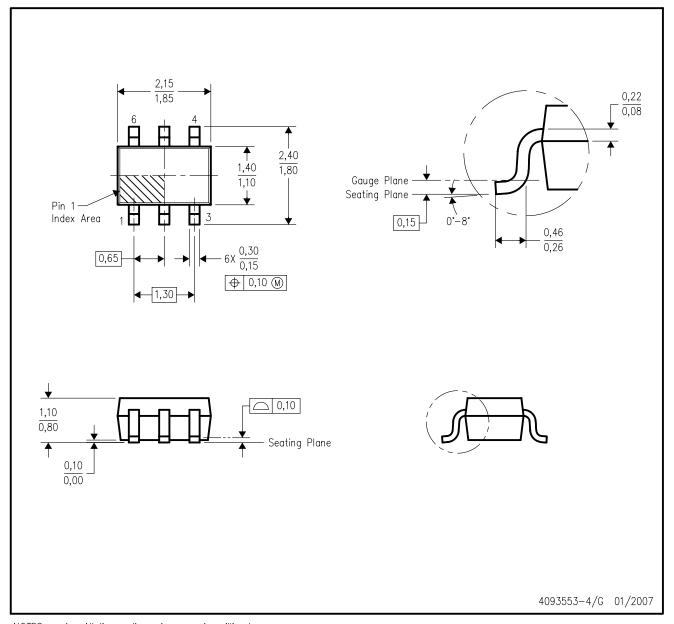
NOTES: All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
 C. QFN (Quad Flatpack No-Lead) package configuration.
 D. This package complies to JEDEC MO-288 variation X2ECD.



DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AB.



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